

RA-150



Reeco RA150

- Wide range of components starting from small resistors to large components like PLCC and PQFP
- Precize temperature control and measurement (accuracy +/- 2oC)
- Unique heating element cool down feature

Advantages

- Heating element power and stable air flow suitable for CHIP, SO, QFP, PLCC, BGA
- Touchless assembling and disassembling of components with hot air
- Microprocessor controlled, precize temperature and air flow stabilization
- Large and readable display
- Extended heating element life time - microprocessor protection
- Wide range of nozzles made of acid-proof steel
- One nozzle and mounting adapter are standard equipment
- Fast nozzle replacement

Technical data

- Input voltage: 230 V AC, 50-60 Hz
- Input power: 320 W max.
- Air flow control range: 2-20 l/min, +/- 10%
- Temperature control range: 150°C - 475°C
- Adjustment/display resolution: 1°C; 1 l/min
- Temperature stability: +/- 2°C
- Ext. dimensions: 240 x 190 x 125 mm
- Weight: 3 kg

Standard equipment	Optional equipment
<ul style="list-style-type: none">• RA-150 hot air station• 1 nozzle	<ul style="list-style-type: none">• PCB preheater• Positioning stand• Wide range of nozzles• Consumables